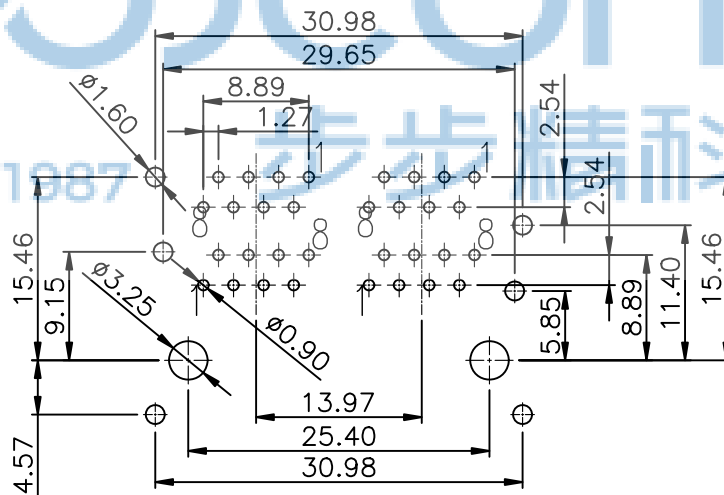
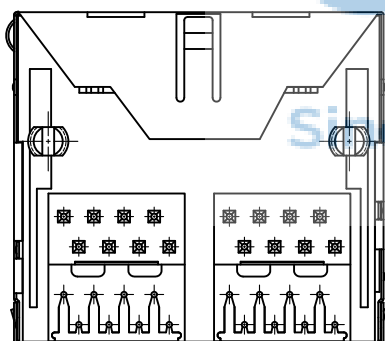
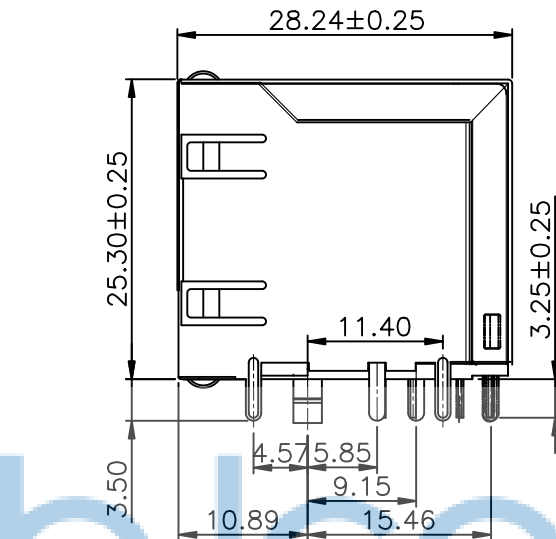
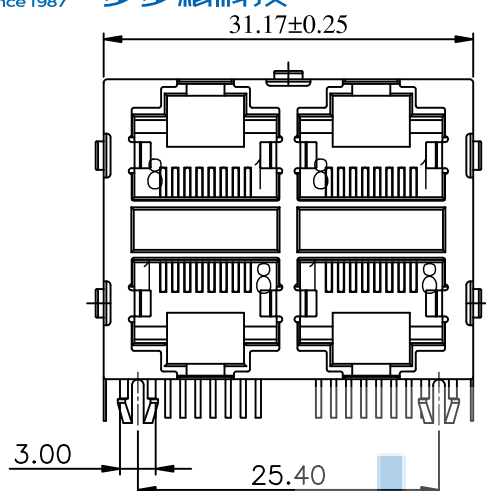


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0			2023 20/04	



PCB LAYOUT/TOP VIEW

MATERIAL:

HOUSING: PA46, PBT, PA66, BLACK.
TERMINAL: PHOSPHOR BRONZE Ø0.46MM
GOLD PLATING

SHIELD: C2680, T=0.20MM, 20 MIN NICKEL PLATING
NO ALL AREA

DURABILITY: 750 CYCLES MIN, 12.5MM/MINUTE.
INSERTION FORCE: 2.2KG.F MAX.
RETENTION STRENGTH: 7.7KG.F BETWEEN JACK AND PLUG.
OPERATING TEMPERATURE: -40 +85
STORAGE TEMPERATURE: -40°C~+85°C.
ALL CRITICAL DIMENSIONS WITH "M"

VOLTAGE: 125 VOLTS AC.
CURRENT RATING: 1.5AMP.
DIELECTRIC STRENGTH: 1000 VAC RMS 50HZ OR 60HZ, 1MIN.
INSULATION RESISTANCE: 500 MEGA OHMS MIN. INITIAL
AFTER 500V DC FOR 1 MINUTE.

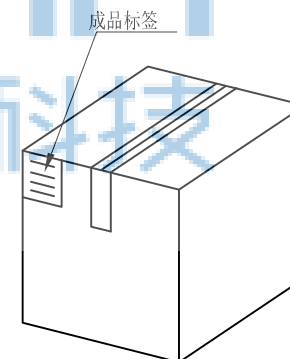
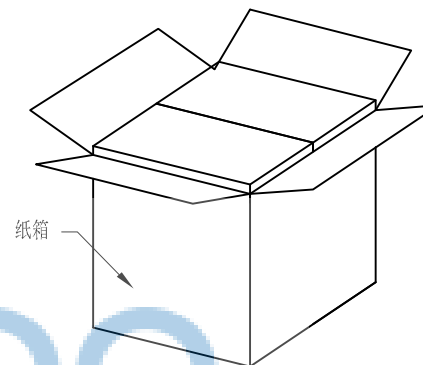
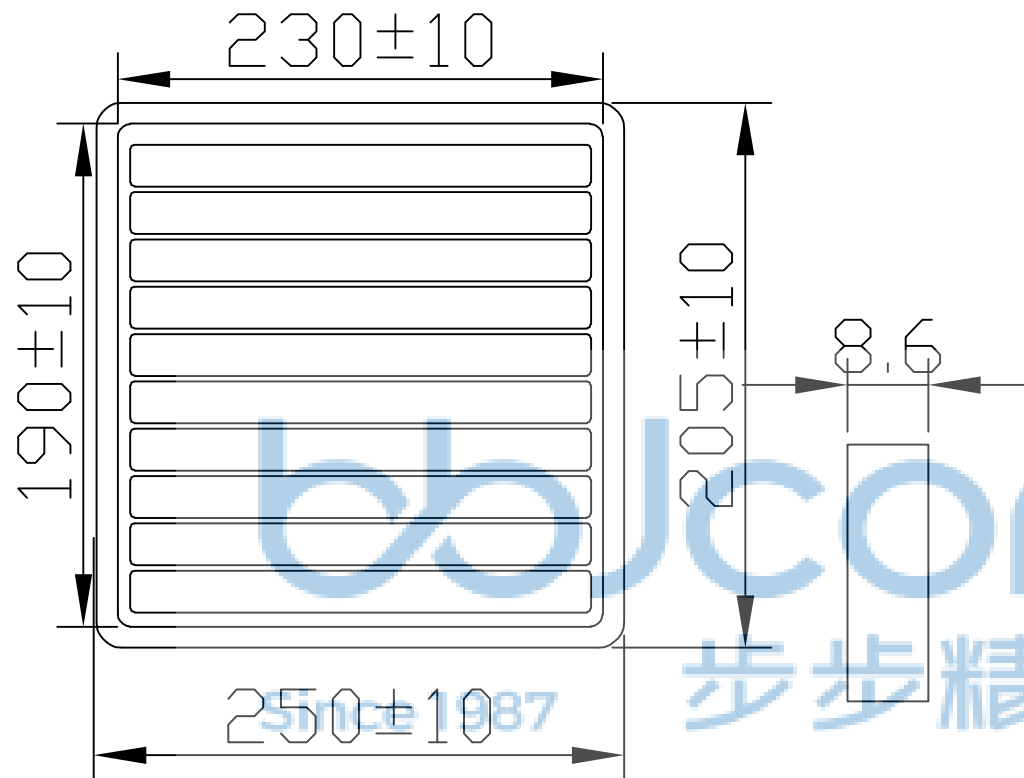
CONTACT RESISTANCE: SINGLE TERMINAL 30 MILLIOHMS MAX.
INITIAL 50 MILLIOHMS MAX. AFTER
DURABILITY TEST.



1	○	J1
2	○	J2
3	○	J3
4	○	J4
5	○	J5
6	○	J6
7	○	J7
8	○	J8

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PDWG, NO: 0067-1

深圳市步步精科技有限公司		NAME:	
.X: ±0.38	X': ±3'	网络接口 RJ45 5921 8P8C 2x2 90度 L=28.24 无灯 带弹 全包 DIP	
.XX: ±0.25	.X': ±2'	APPD. JM_Zheng	PJ. NO.: RJ.01.32-14-1001
.XXX: ±0.13	.XX': ±1'	CHKD. TSP	SIZE: A4 DRW NO.:
		DR. LYX	FINISH: SEE NOTES MAT'L.: SEE NOTES
			SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/2



纸箱规格: 350*210*290

1. 包装要求:

- 1.1 每盒吸塑盒包装20pcs;
- 1.2 每32盘放一箱, 共计640 PCS;
- 1.3 纸箱外贴上标签

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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13			X*: ±3" .X*: ±2" .XX*: ±1"		
APPD. JM_Zheng 23/05'02			NAME: 网络接口 RJ45 5921 8P8C 2x2 90度 L=28.24 无灯 带弹 全包 DIP		
CHKD. TSP 23/05'02			PJ. NO.: RJ.01.32-14-1001 SIZE: A4 DRW NO.:		
PDWG.NO.: 0067-1			FINISH: SEE NOTES SCALE: N/A REV.: A3 UNIT: mm PAGE: 2/2		
DR. LYX 23/05'02			MAT'L.: SEE NOTES		